Please note that Cypress is an Infineon Technologies Company.
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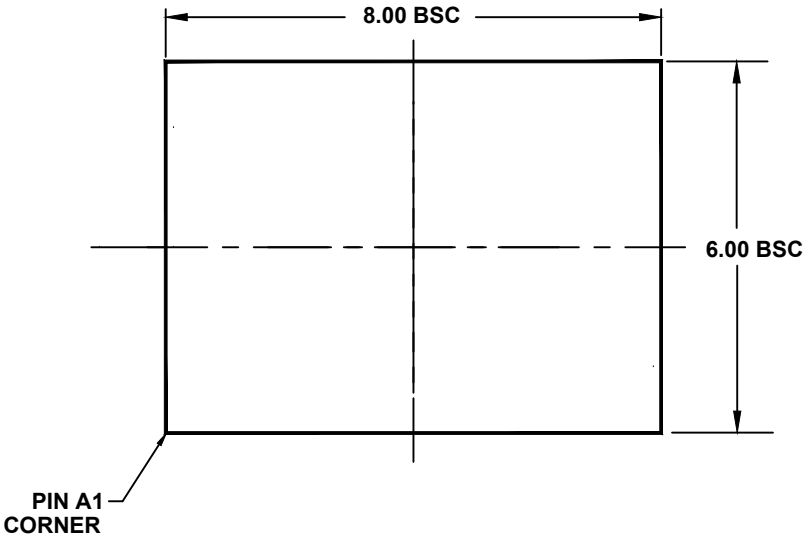
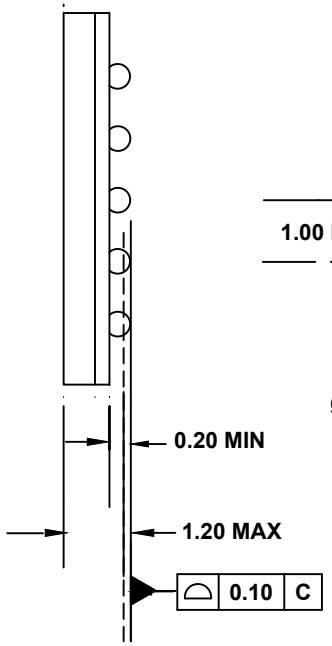
Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

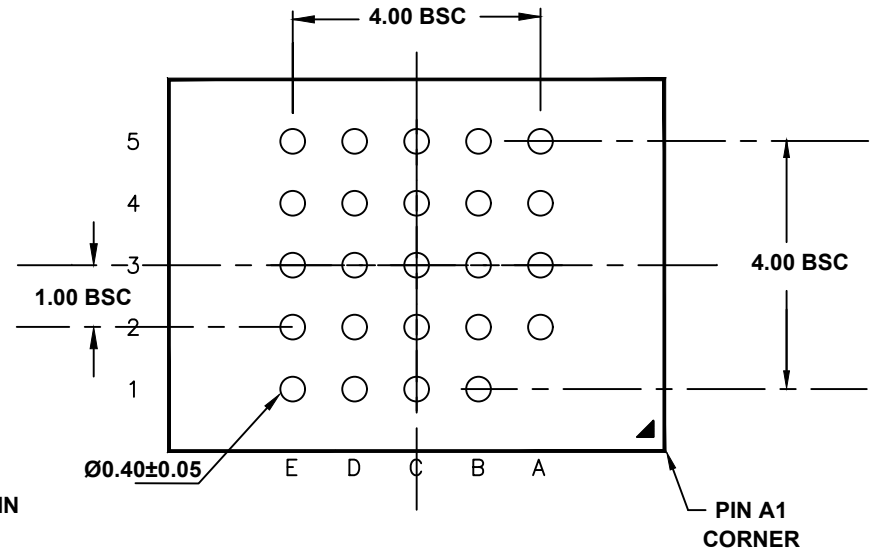
TOP VIEW



SIDE VIEW



BOTTOM VIEW



NOTES:

1. REFERENCE JEDEC # MO-216
2. ALL DIMENSIONS ARE IN MILLIMETERS

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PACKAGE CODE(S)	BK24A	ZMA024	ZLA024

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TITLE: PACKAGE OUTLINE, 24L FBGA 8X6X1.2MM
BK24A/ZMA024/ZLA024

SPEC NO. 001-97209 | REV *A

SCALE: 1:1 | SHEET 1 OF 2

Rev.	ECN No.	Orig	Description of Change
**	4723350	JVP	NEW RELEASE
*A	7027250	KOTA	Add package code ZMA024/ZLA024

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PACKAGE CODE(S)	BK24A	ZMA024	ZLA024

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TITLE
PACKAGE OUTLINE, 24L FBGA 8X6X1.2MM
BK24A/ZMA024/ZLA024

SPEC NO. 001-97209 | REV *A

SCALE: 1:1 | SHEET 2 OF 2